

# Two Days Faculty Development Program (FDP) on "TRENDS IN TECHNOLOGICAL INTELLIGENCE (T<sup>2</sup>I- 2020)"

Organized by the IET student chapter of Electronics and Communication Engineering & Department of Electrical Engineering, BBDNIT, Lucknow  
(May 31 – June 01, 2020)

**Babu Banarasi Das Northern India Institute of Technology  
LUCKNOW (AKTU CODE: 056)**

It is our immense pleasure to announce that IET student chapter of Electronics and Communication Engineering & Department of Electrical Engineering, BBDNIT, Lucknow is organizing Two Days Faculty Development Program (FDP) on "Trends in Technological Intelligence (T<sup>2</sup>I- 2020)" for faculty members of Engineering Institutes, scheduled from **May 31 to June 01 2020** (Tentative Time : 04:00 PM to onwards).

**Faculty Development Program**

**Trends in Technological Intelligence (T<sup>2</sup>I- 2020)**

**May 31 - June 01, 2020**

**Organized by the IET Student Chapter of Electronics and Communication Engineering & Department of Electrical Engineering, BBDNIT, Lucknow**

**In association with The Institution of Engineers (IET)**

**Resource Persons**

**Dr. Mukesh Kumar**  
Associate Professor, Department of Electrical Engg., IIT, Indore, MP, India

**Dr. Anand Kumar**  
Associate Professor, Department of Electrical Engg., IIT, Indore, MP, India

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Associate Professor, Department of Electrical Engg., IIT, Indore, MP, India

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**Registration Details**

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The objective of the online faculty development program is to create learning experiences about the recent trends in technological development in diverse fields.

**TITLE: "Trends in Technological Intelligence (T<sup>2</sup>I- 2020)"**

**Keynote Speaker:**

**1. Dr. Mukesh Kumar**

Associate Professor, Department of Electrical Engg., IIT, Indore, MP, India

**Topic: On-Chip Optoelectronic Devices for Optical Communication and Interconnects**